2SK3018

SOT-323 Plastic-Encapsulate MOSFETS

FEATURES

- VDS (V) = 30V ID = 0.1 A RDS(ON) < 8 Ω

- (VGS = 4 V) RDS(ON) < 13 Ω (VGS = 2.5 V)
- Low on-resistance
- Fast switching speed
- Low voltage drive makes this device ideal for
- Portable equipment
- Easily designed drive circuits
- Easy to parallel
- N-channel MOSFET

MECHANICAL DATA

- Case style:SOT-323molded plastic

- Mounting position:any

SOT-323   Unit:mm

1. Gate
2. Source
3. Drain

MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	100	mA
Pulsed Drain Current (Note.1)	I_{DM}	400	mA
Power Dissipation	P_D	150	mW
Junction Temperature	T_J	150	℃
Storage Temperature Range	T_{stg}	-55 to 150	℃

Mosfet Electrical Characteristics TA=25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	I_D=250μA, V_{GS}=0V	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	I_{GSS}	V_{DS}=0V, V_{GS}=±20V			±1	uA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=3V , I_D=0.1mA	0.8		1.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=4V, I_D=10mA			8	Ω
		V_{GS}=2.5V, I_D=1mA			13	
Forward Transconductance	g_{FS}	V_{DS}=3V, I_D=10mA	20			mS
Input Capacitance	C_{iss}	V_{GS}=0V, V_{DS}=5V, f=1MHz		13		pF
Output Capacitance	C_{oss}			9		pF
Reverse Transfer Capacitance	C_{rss}			4		pF
Turn-On DelayTime	$t_{d(on)}$	V_{GS}=5V, V_{DS}=5V, I_D=10mA,R_L=500Ω, R_G=10Ω		15		ns
Turn-On Rise Time	t_r			35		ns
Turn-Off DelayTime	$t_{d(off)}$			80		ns
Turn-Off Fall Time	t_f			80		ns

RATINGS AND CHARACTERISTIC CURVES

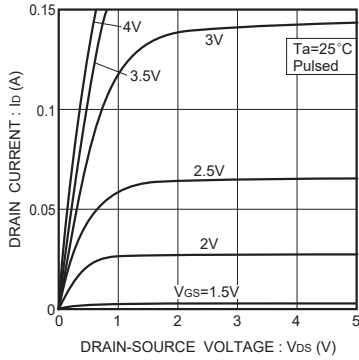■ Typical Characterisitics

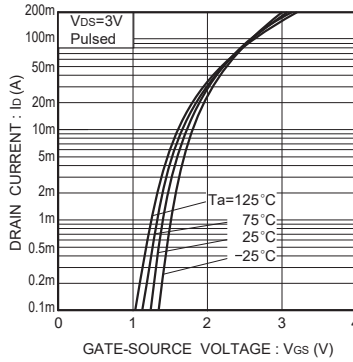Fig.1 Typical output characteristics
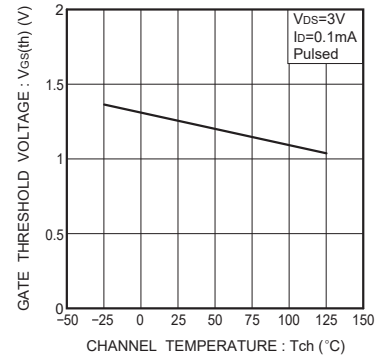

Fig.2 Typical transfer characteristics

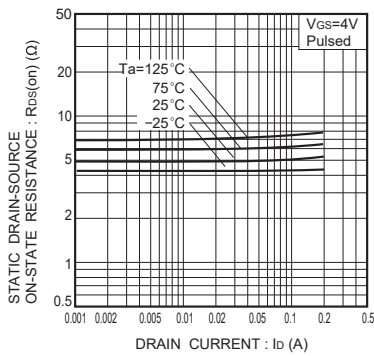Fig.3 Gate threshold voltage vs. channel temperature

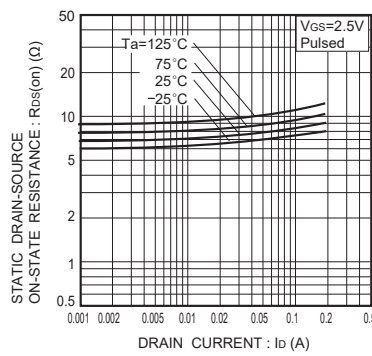Fig.4 Static drain-source on-state resistance vs. drain current (I)

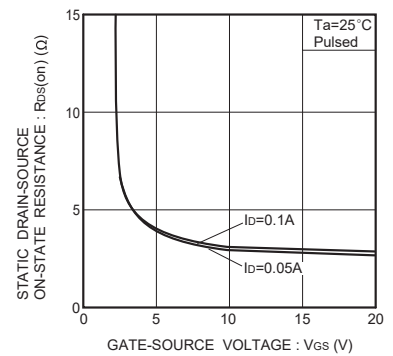Fig.5 Static drain-source on-state resistance vs. drain current (II)

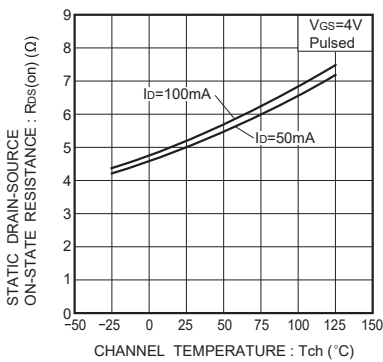Fig.6 Static drain-source on-state resistance vs. gate-source voltage
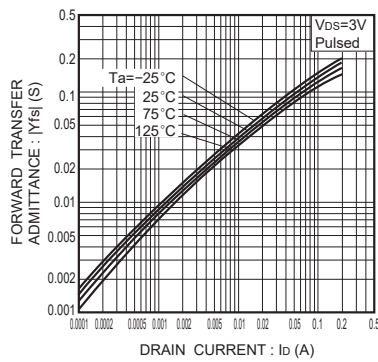

Fig.7 Static drain-source on-state resistance vs. channel temperature

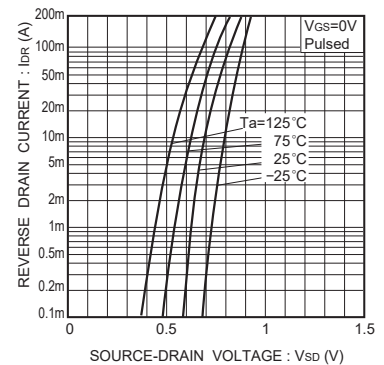

Fig.8 Forward transfer admittance vs. drain current

Fig.9 Reverse drain current vs. source-drain voltage (I)

RATINGS AND CHARACTERISTIC CURVES
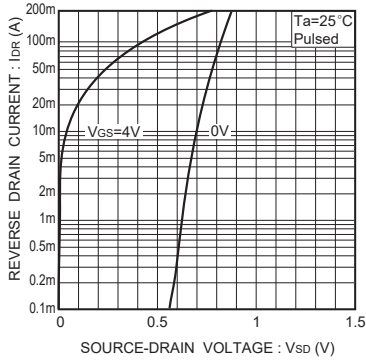
■ Typical Characterisitics

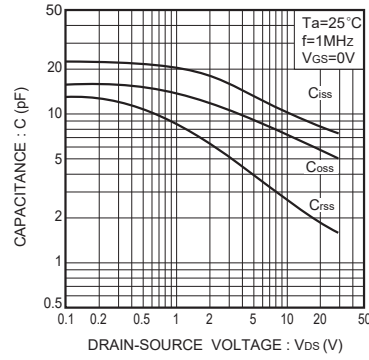Fig.10 Reverse drain current vs. source-drain voltage (II)

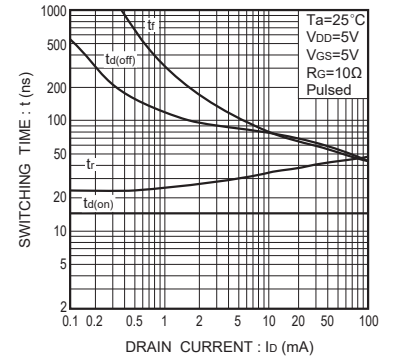Fig.11 Typical capacitance vs. drain-source voltage

Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)
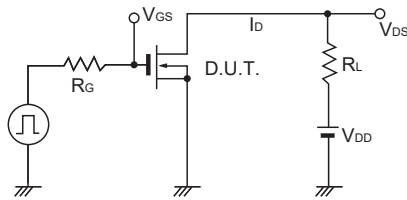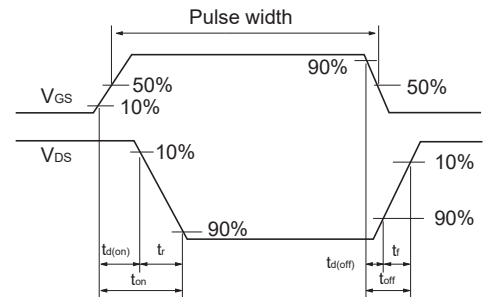

Fig.13 Switching time measurement circuit

Fig.14 Switching time waveforms